

Bi-Directional N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY		
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
30	0.019 at V _{GS} = 4.5 V	10.7
	0.0195 at V _{GS} = 4.0 V	10.5
	0.022 at V _{GS} = 3.1 V	9.9
	0.027 at V _{GS} = 2.5 V	9.0

FEATURES

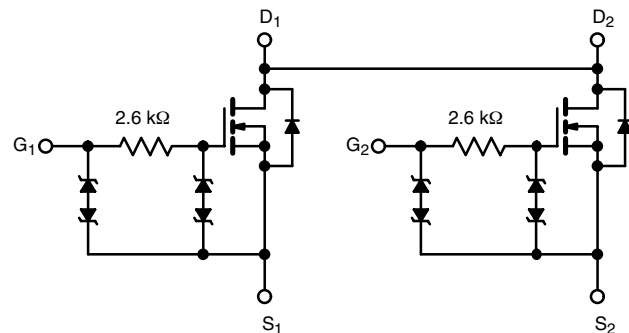
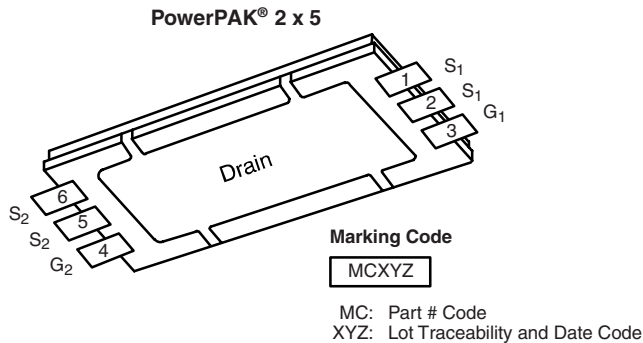
- Halogen-free
- TrenchFET[®] Power MOSFET: 2.5 V Rated
- ESD Protected: 3000 V



RoHS
COMPLIANT

APPLICATIONS

- Battery Protection Circuitry
- 1-Cell Li-Ion Battery Pack
 - LiB/LiP
 - Lithium-Polymer



Ordering Information: SiF912EDZ-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter	Symbol	10 s	Steady State	Unit	
Drain-Source Voltage	V _{DS}	30		V	
Gate-Source Voltage	V _{GS}	± 12			
Continuous Drain Current (T _J = 150 °C) ^a	I _D	T _A = 25 °C	10.7	7.4	A
		T _A = 85 °C	7.7	5.3	
Pulsed Drain Current (V _{GS} = 8 V, 10 μs)	I _{DM}	80			
Continuous Diode Current (Diode Conduction) ^a	I _S	2.9	1.3	W	
Maximum Power Dissipation ^a	P _D	T _A = 25 °C	3.5		1.6
		T _A = 85 °C	1.8	0.86	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	R _{thJA}	t ≤ 10 s	30	36	°C/W
		Steady State	61	76	
Maximum Junction-to-Case (Drain)	R _{thJC}	4.5	5.6		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

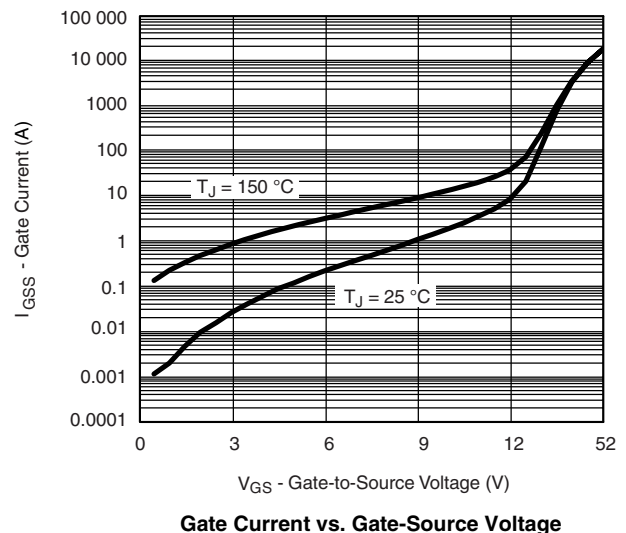
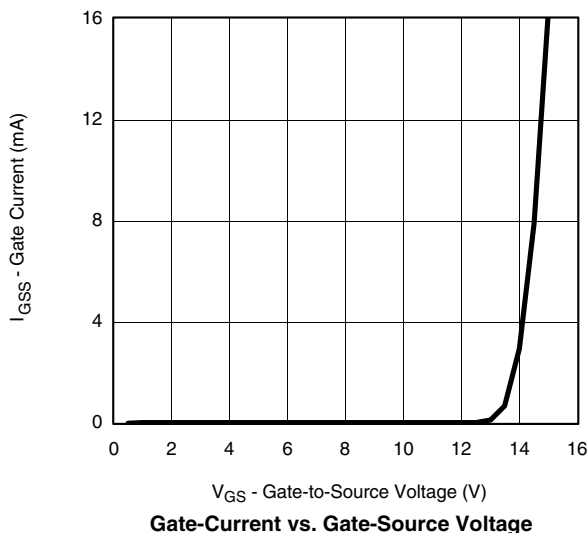
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	0.6		1.5	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 4.5\text{ V}$			± 10	μA
		$V_{DS} = 0\text{ V}, V_{GS} = \pm 12\text{ V}$			± 500	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$			1	
		$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}, T_J = 85\text{ }^\circ\text{C}$			5	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} = 5\text{ V}, V_{GS} = 4.5\text{ V}$	40			A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 4.5\text{ V}, I_D = 7.4\text{ A}$		0.0155	0.019	Ω
		$V_{GS} = 4.0\text{ V}, I_D = 7.3\text{ A}$		0.016	0.0195	
		$V_{GS} = 3.1\text{ V}, I_D = 6.8\text{ A}$		0.018	0.022	
		$V_{GS} = 2.5\text{ V}, I_D = 3.5\text{ A}$		0.022	0.027	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 10\text{ V}, I_D = 7.4\text{ A}$		37		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.9\text{ A}, V_{GS} = 0\text{ V}$		0.75	1.1	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 7.4\text{ A}$		9.8	15	nC
Gate-Source Charge	Q_{gs}			2.5		
Gate-Drain Charge	Q_{gd}			2.9		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15\text{ V}, R_L = 15\text{ }\Omega$ $I_D \cong 1\text{ A}, V_{GEN} = 10\text{ V}, R_g = 6\text{ }\Omega$		0.53	0.8	μs
Rise Time	t_r			0.70	1.1	
Turn-Off Delay Time	$t_{d(off)}$			8.0	12	
Fall Time	t_f			3.4	5	

Notes:

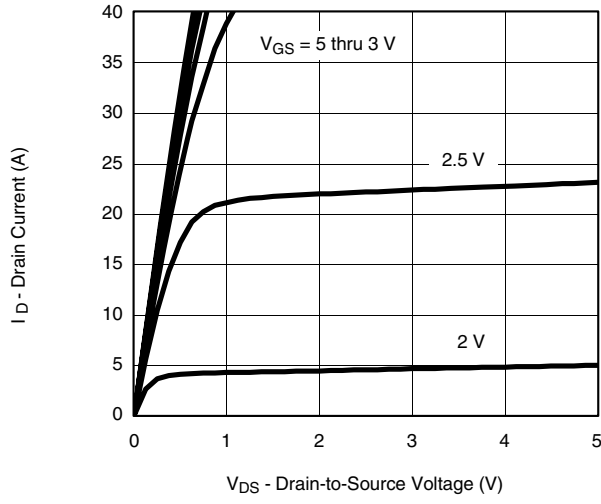
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

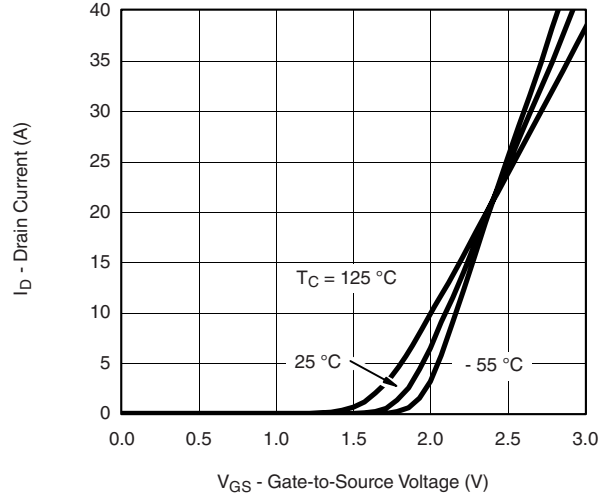
TYPICAL CHARACTERISTICS $25\text{ }^\circ\text{C}$, unless otherwise noted



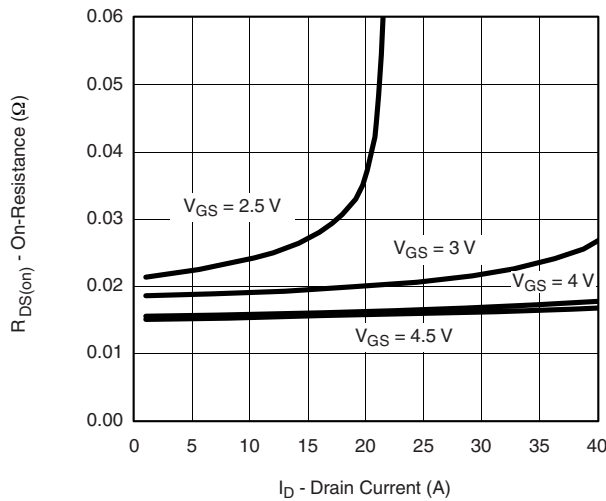
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



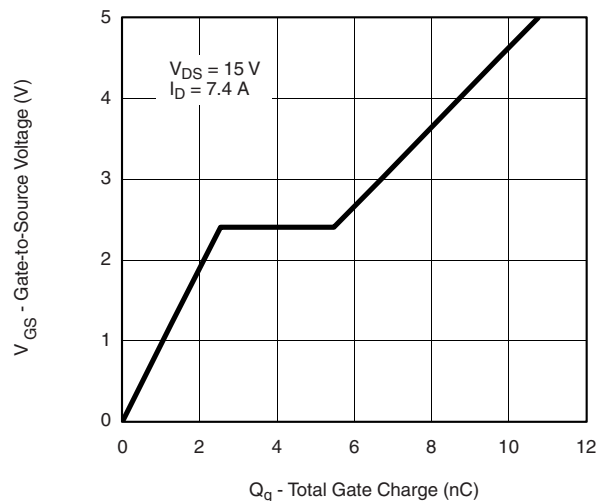
Output Characteristics



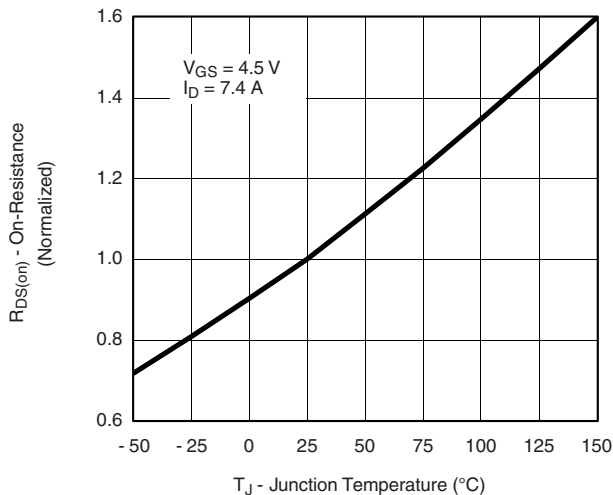
Transfer Characteristics



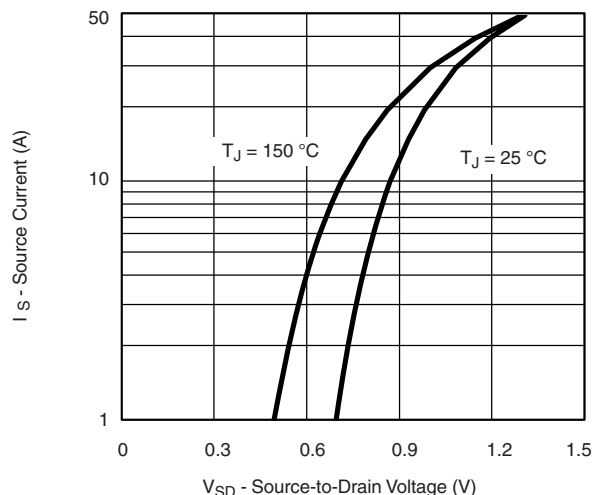
On-Resistance vs. Drain Current



Gate Charge

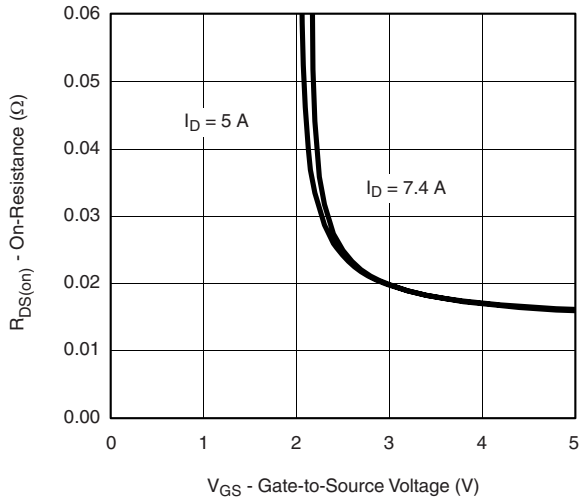


On-Resistance vs. Junction Temperature

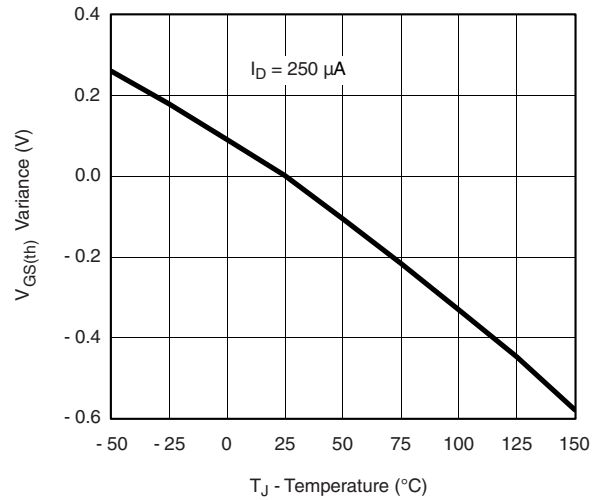


Source-Drain Diode Forward Voltage

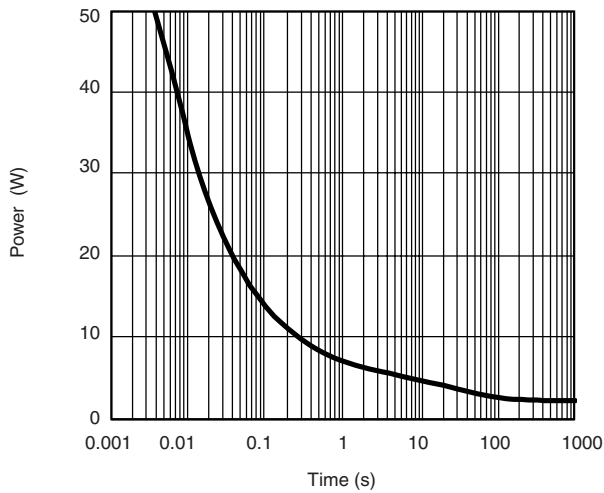
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



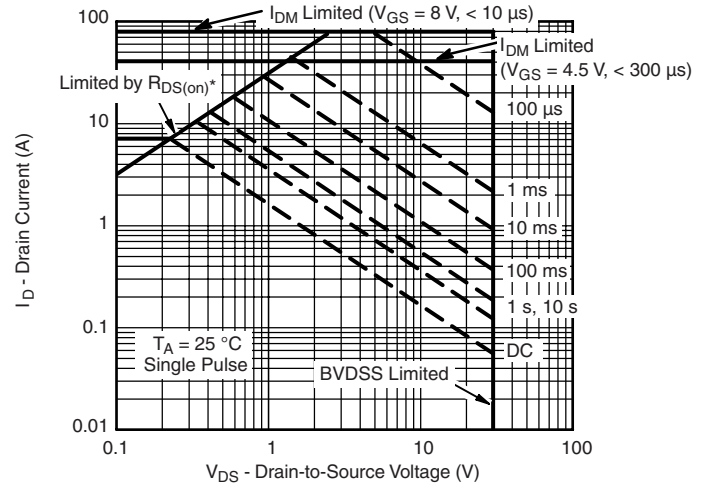
On-Resistance vs. Gate-to-Source Voltage



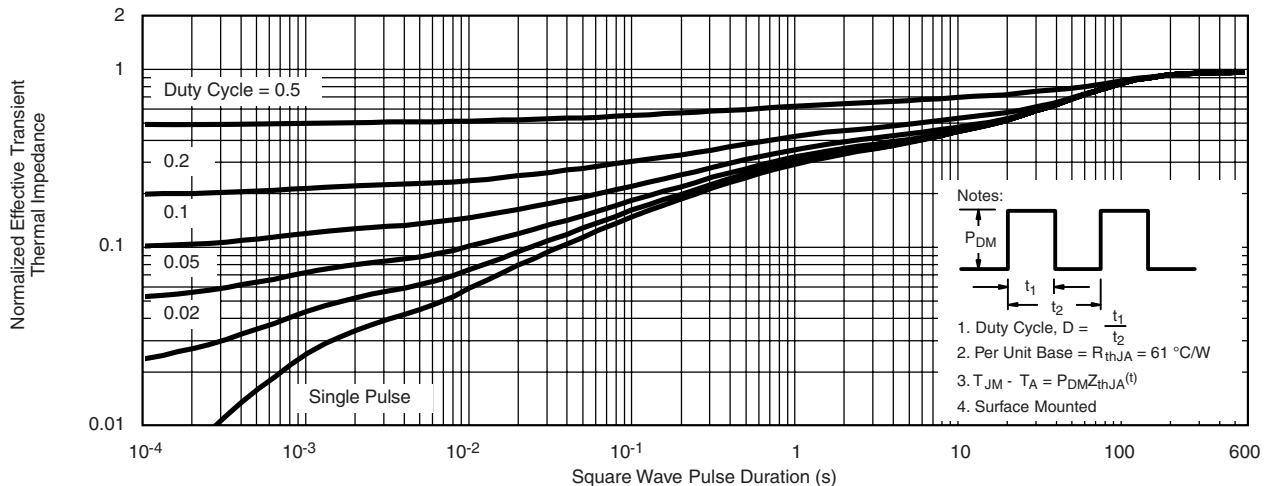
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



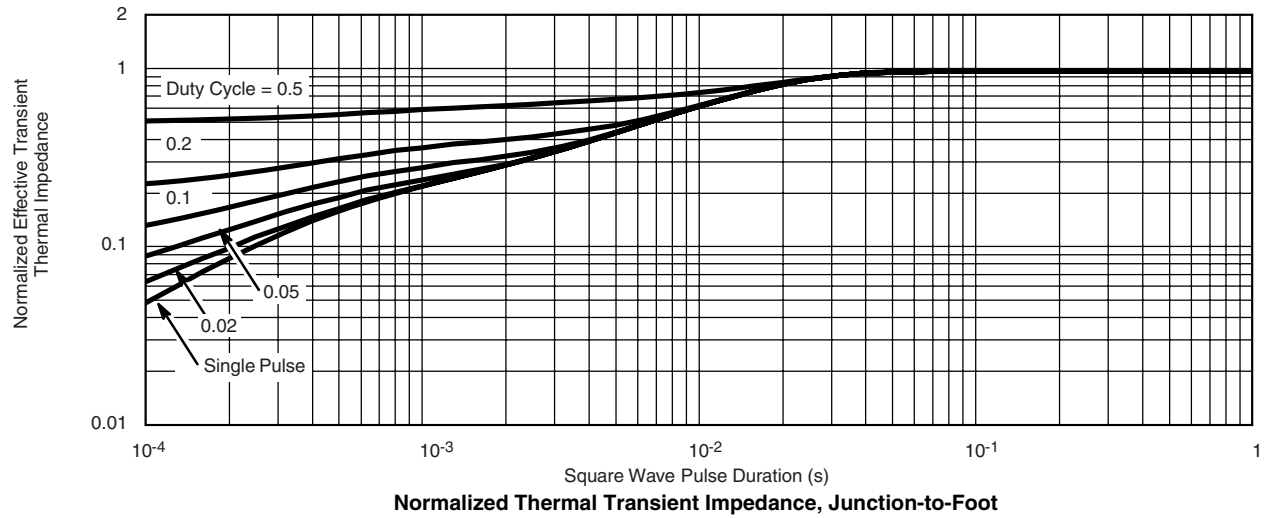
Safe Operating Area
* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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